VS-GT600TH060S



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Half Bridge, 600 A, DIAP IGBT Power Module (Trench Field Stop IGBT)



PRIMARY CHARACTERISTICS						
V _{CES}	600 V					
I _C DC at T _C = 71 °C	600 A					
V _{CE(on)} (typical) at 600 A, 25 °C	1.29 V					
Speed	DC to 1 kHz					
Package	Dual INT-A-PAK					
Circuit configuration	Half bridge					

FEATURES

- TrenchStop IGBT technology
- Standard: optimized for hard switching speed
- Low V_{CE(on)}
- Square RBSOA
- Gen 4 FRED Pt[®] dices technology
- Industry standard package
- Al₂O₃ DBC
- Designed for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Increased operating efficiency
- Performance optimized as output inverter stage for TIG welding machines
- Direct mounting on heatsink
- · Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
Continuous collector current	I _C ⁽¹⁾	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	755		
Continuous collector current	IC (.)	T _C = 80 °C	565		
Pulsed collector current	I _{CM}	$T_{C} = 175 \text{ °C}, t_{p} = 6 \text{ ms}, V_{GE} = 15 \text{ V}$	1000	А	
Clamped inductive load current	I _{LM}		n/a		
Diode continuous forward current	I _F	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	272		
		T _C = 80 °C	202		
Gate to emitter voltage	V _{GE}		± 20	V	
	P _D	T _C = 25 °C	1364	w	
Maximum power dissipation (IGBT)		T _C = 80 °C	864		
Maximum neuror discinction (Diada)	Р	$T_{\rm C} = 25 ^{\circ}{\rm C}$	468	W	
Maximum power dissipation (Diode)	PD	T _C = 80 °C	297		
RMS isolation voltage	V _{ISOL}	Any terminal to case ($V_{RMS} t = 1 s, T_J = 25 °C$)	3500	v	

Note

(1) Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals

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COMPLIANT



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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 V, I_C = 1.2 mA$	600	-	-		
Collector to emitter voltage	V _{CE(on)}	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 600 \text{ A}$	-	1.29	1.64	v	
		V_{GE} = 15 V, I_{C} = 600 A, T_{J} = 125 °C	-	1.36	-	v	
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 6 \text{ mA}$	3.8	4.8	6.3]	
Collector to emitter lookage ourrent	I _{CES}	$V_{GE} = 0 V, V_{CE} = 600 V$	-	0.3	200		
Collector to emitter leakage current		V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 125 °C	-	280	-	μΑ	
Diada famuard valtage drep	V _{FM}	I _{FM} = 400 A	-	1.66	2.3	V	
Diode forward voltage drop		I _{FM} = 400 A, T _J = 125 °C	-	1.57	-	v	
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 200	nA	

SWITCHING CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg		-	2665	-		
Gate-to-emitter charge (turn-on)	Q _{ge}	$I_{C} = 75$ A, $V_{CC} = 520$ V, $V_{GE} = 15$ V	-	445	-	nC	
Gate-to-collector charge (turn-on)	Q _{gc}		-	750	-		
Turn-on switching loss	Eon		-	75	-		
Turn-off switching loss	E _{off}	$I_{C} = 600$ A, $V_{CC} = 300$ V, $V_{GE} = 15$ V, R _q = 27 Ω, L = 500 µH, T _J = 25 °C	-	72	-		
Total switching loss	E _{tot}	ng = 27 32, E = 000 pm, nj = 20 °C	-	147	-		
Turn-on switching loss	Eon		-	39	-	mJ	
Turn-off switching loss	E _{off}		-	53	-		
Total switching loss	E _{tot}		-	92	-		
Turn-on delay time	t _{d(on)}	I _C = 600 A, V _{CC} = 300 V, V _{GE} = 15 V, R _a = 27 Ω, L = 500 μH, T _J = 125 °C	-	580	-		
Rise time	t _r	hg = 27 s2, Ε = 300 μH, HJ = 120 O	-	290	-		
Turn-off delay time	t _{d(off)}		-	2540	-	ns	
Fall time	t _f		-	130	-		
Reverse bias safe operating area	RBSOA	$ \begin{array}{l} T_J = 175 \; ^\circ \!\! C, \; I_C = n/a, \; V_{CC} = 300 \; V, \\ V_p = 600 \; V, \; R_g = 27 \; \Omega, \\ V_{GE} = 15 \; V \; to \; {\rm -5} \; V, \; L = 500 \; \mu {\rm H} \end{array} $		n/a			
Diode reverse recovery time	t _{rr}		-	152	-	ns	
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 500 A/μs, V _{CC} = 200 V, T _J = 25 °C	-	24	-	Α	
Diode recovery charge	Q _{rr}		-	1.82	-	μC	
Diode reverse recovery time	t _{rr}		-	200	-	ns	
Diode peak reverse current	l _{rr}	I _F = 50 A, dI _F /dt = 500 A/μs, V _{CC} = 200 V, T _J = 125 °C	-	39	-	Α	
Diode recovery charge	Q _{rr}		-	3.94	-	μC	

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Operating junction temperature range		TJ	-40	-	175	°C	
Storage temperature range		T _{Stg}	-40	-	150	°C	
Junction to case per leg Diode		Т	-	-	0.11	°C/W	
		e R _{thJC}	-	-	0.32		
Case to sink per module		R _{thCS}	-	0.05	-		
Mounting torque	case to heatsink: M6 scree	N	2.5	-	5	Nm	
	case to terminal 1, 2, 3: M6 scree	N	3	-	5		
Weight			-	270	-	g	

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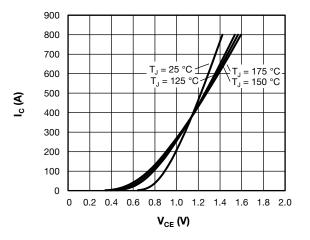


Fig. 1 - Typical Q1 to Q2 IGBT Output Characteristics, $V_{GE} = 15 V$

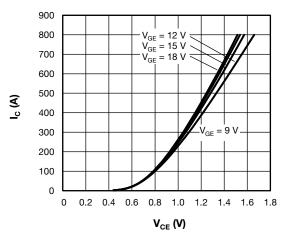


Fig. 2 - Typical Q1 to Q2 IGBT Output Characteristics, T_J = 125 °C

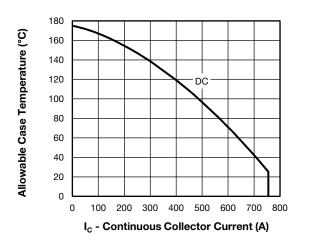


Fig. 3 - Maximum Q1 to Q2 IGBT Continuous Collector Current vs. Case Temperature

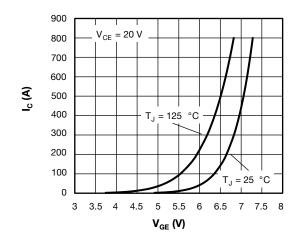


Fig. 4 - Typical Q1 to Q2 IGBT Transfer Characteristics

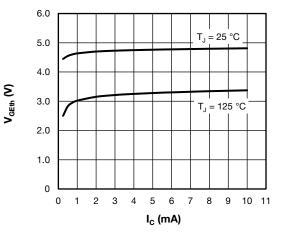


Fig. 5 - Typical Q1 to Q2 IGBT Gate Threshold Voltage

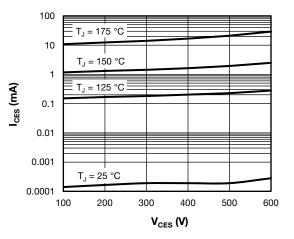


Fig. 6 - Typical Q1 to Q2 IGBT Zero Gate Voltage Collector Current

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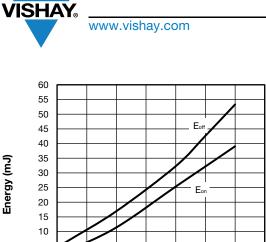
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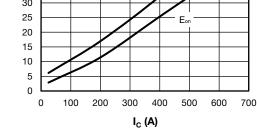


Fig. 7 - Typical Q1 to Q2 IGBT Energy Loss vs. I_C (with D1 to D2 Antiparallel Diode) T_J = 125 °C, V_{CC} = 300 V, R_g = 27 Ω , V_{GE} = +15 V/-15 V, L = 500 μ H

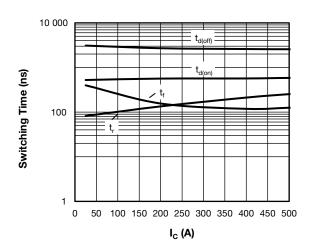
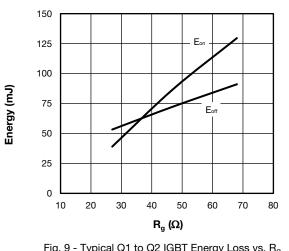
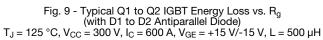


Fig. 8 - Typical Q1 to Q2 IGBT Switching Time vs. I_C (with D1 to D2 Antiparallel Diode) T_J = 125 °C, V_{CC} = 300 V, R_g = 27 Ω , V_{GE} = +15 V/-15 V, L = 500 µH





10 000 Switching Time (ns) 1000 t_{d(on)} t 100 10 30 10 20 40 50 60 70 80 $\mathbf{R}_{g}\left(\Omega\right)$

Fig. 10 - Typical Q1 to Q2 IGBT Swithcing Time vs. R_g (with D1 to D2 Antiparallel Diode) T_J = 125 °C, V_{CC} = 300 V, I_C = 600 A, V_{GE} = +15 V/-15 V, L = 500 μH

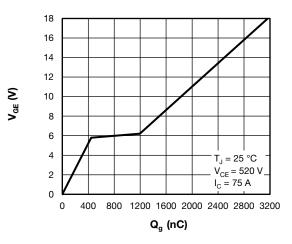


Fig. 11 - Typical Q1 to Q2 IGBT Gate Charge vs. Gate to Source Voltage

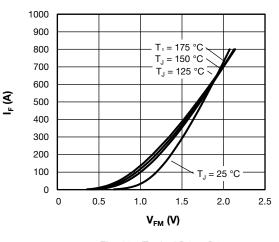


Fig. 12 - Typical D1 to D2 Antiparallel Diode Forward Characteristics

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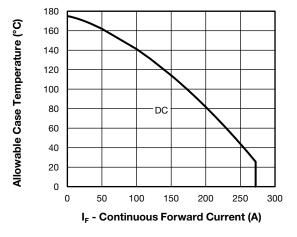
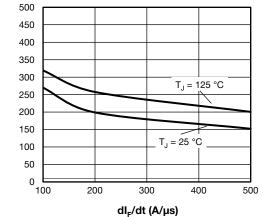
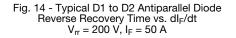
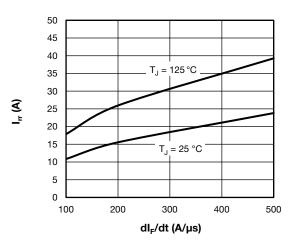
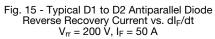


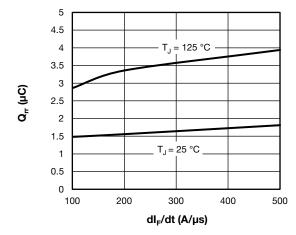
Fig. 13 - Maximum D1 to D2 Antiparallel Diode Continuous Forward Current vs. Case Temperature

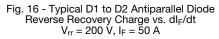












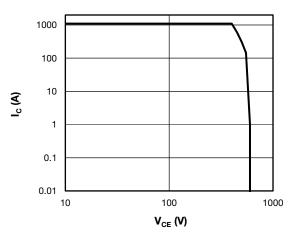


Fig. 17 - Q1 to Q2 IGBT Reverse BIAS SOA T_J = 175 °C, V_{GE} = 15 V T_J = 175 °C, I_C = 1100 A, R_g = 27 Ω , V_{GE} = +15 V/0 V, V_{CC} = 400 V, V_p = 600 V

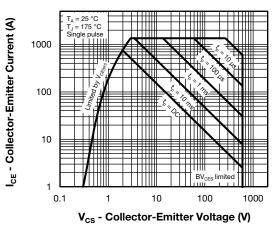


Fig. 18 - Q1 to Q2 IGBT Safe Operating Area

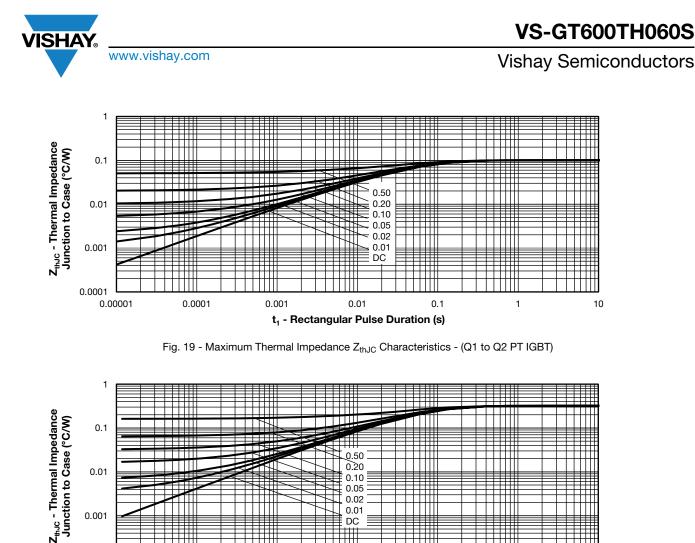
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t₁ - Rectangular Pulse Duration (s)

Fig. 20 - Maximum Thermal Impedance Z_{thJC} Characteristics - (D1 to D2 Antiparallel Diode)

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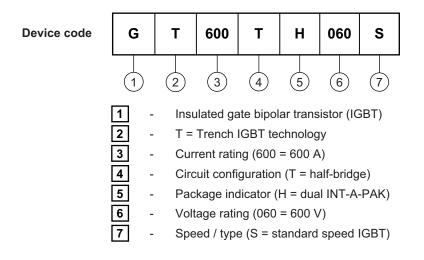
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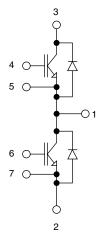
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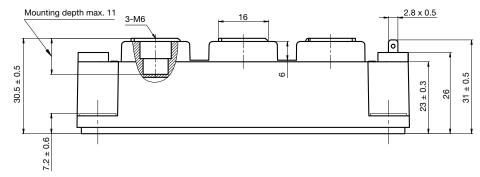
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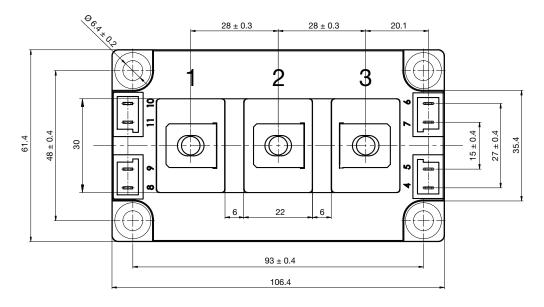
CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95435			
Application Note	www.vishay.com/doc?95553			

DIMENSIONS in millimeters







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Revision: 01-Jan-2025

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